

분과초청 2

In -- situ solid phase epitaxial growth of C49 and C54-TiSi₂ on the Si(111)-7×7 substrate

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The growth of mode of Ti film on the Si(111)-7×7 surface and the solid phase heteroepitaxial growth of Si/C54 TiSi₂/Si(111) were investigated by x-ray diffraction, reflection high energy electron diffraction and high resolution transmission electron microscopy. The growth mode of Ti film on Si(111)-7×7 substrate at RT is a Stranski-Krastanov type. The grown Ti film shows polycrystalline but highly oriented to the substrate with an amorphous Ti-Si alloy layer at the Ti/Si interface. Epitaxial C49 and C54-TiSi₂ can be grown from the Ti(30ML)/Si(111)-7×7 sample by *in-situ* annealing at 650°C and 750°C for 20min.

When the deposited thickness of the Ti film exceeded 30ML, agglomeration due to grain boundary grooving took place, which resulted the formation of silicide islands. Images of cross-sectional transmission electron microscopy showed that the epi-TiSi₂/Si(111) interface was abrupt and no amorphous Ti-Si interlayer is observed, and the surface is smooth. The orientation relationships between epitaxial C54-TiSi₂ and Si(111) substrate are determined to be TiSi₂[$\bar{1}\bar{4}1$]/Si[0 $\bar{1}1$], TiSi₂(202)/Si(111) whereas those between C49-TiSi₂ and Si(111) substrate are TiSi₂[$\bar{2}11$]/Si[0 $\bar{1}\bar{1}$], TiSi₂(120)/Si(111) without misorientation angle.

Almost the whole area of the sample was covered with the epitaxial TiSi₂ layer of 22 nm thick. We have also shown that high quality double heteroepitaxial epi-Si/epi-C54 TiSi₂/Si(111) can be grown by SPE. The matching face relation is Si(111)//C54($\bar{2}02$)/Si(111) without misorientation angle, which was obtained by deposition of 10ML of Si film on the C54-TiSi₂ film at 600°C followed by *in-situ* annealed at 800°C for 10min in UHV.